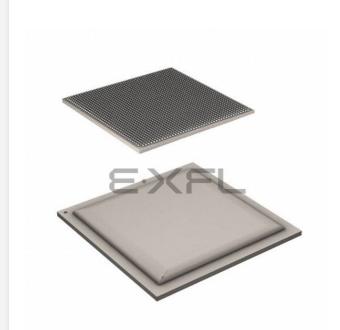
# E·XFL



#### Welcome to E-XFL.COM

#### Understanding Embedded - Microprocessors

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

#### Applications of **Embedded - Microprocessors**

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

#### Details

Product Status	Active
Core Processor	PowerPC e6500
Number of Cores/Bus Width	8 Core, 64-Bit
Speed	1.8GHz
Co-Processors/DSP	·
RAM Controllers	DDR3, DDR3L
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	1Gbps (13), 10Gbps (2)
SATA	SATA 3Gbps (2)
USB	USB 2.0 + PHY (2)
Voltage - I/O	·
Operating Temperature	0°C ~ 105°C (TA)
Security Features	Boot Security, Cryptography, Secure Fusebox, Secure Debug, Tamper Detection, Volatile key Storage
Package / Case	1932-BBGA, FCBGA
Supplier Device Package	1932-FCPBGA (45x45)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/t4160nse7pqb

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



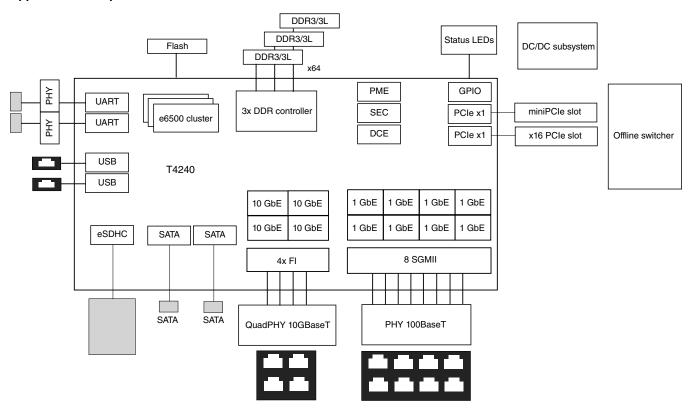


Figure 1. SoC 1U security appliance

# 3.2 Rack-mounted services blade

Networking and telecom systems are frequently modular in design, built from multiple standard dimension blades, which can be progressively added to a chassis to increase interface bandwidth or processing power. ATCA is a common standard form factor for chassis-based systems.

This figure shows a potential configuration for an ATCA blade with four chips and an Ethernet switch, which provides connectivity to the front panel and backplane, as well as between the chips. Potential systems enabled by chips in ATCA style modular architectures are described below.

Application examples

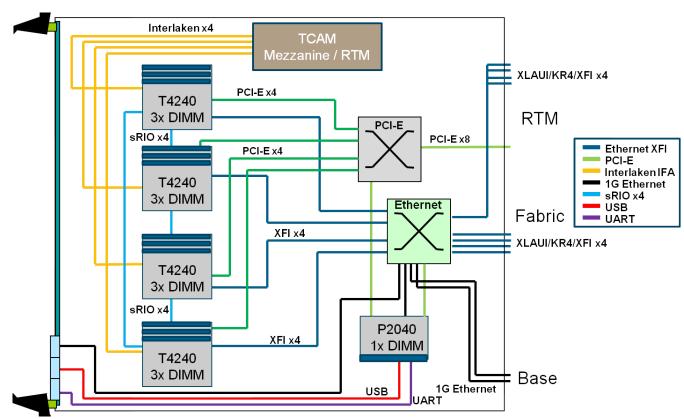


Figure 2. Network services ATCA blade

# 3.3 Radio node controller

Some of the more demanding packet-processing applications are found in the realm of wireless infrastructure. These systems have to interwork between wireless link layer protocols and IP networking protocols. Wireless protocol complexity is high, and includes scheduling, retransmission, and encryption with algorithms specific to cellular wireless access networks. Connecting to the IP network offers wireless infrastructure tremendous cost savings, but introduces all the security threats found in the IP world. The chip's network and peripheral interfaces provide it with the flexibility to connect to DSPs, and to wireless link layer framing ASICs/FPGAs (not shown). While the Data Path Acceleration Architecture offers encryption acceleration for both wireless and IP networking protocols, in addition to packet filtering capability on the IP networking side, multiple virtual CPUs may be dedicated to data path processing in each direction.



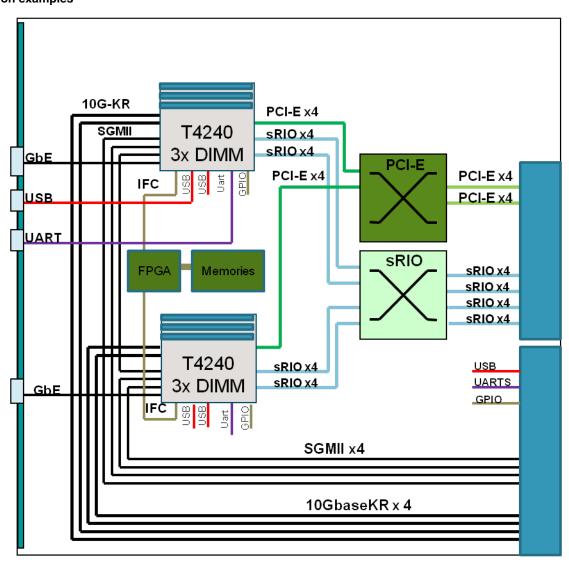


Figure 3. Radio node controller

# 3.4 Intelligent network adapter

The exact form factor of this card may vary, but the concepts are similar. A chip is placed on a small form factor card with an x8 PCIe connector and multiple 10 G Ethernet ports with HighGigE support for integrating with a Trident II device. This card is then used as inline accelerator that provides both line rate networking and intelligent programmable offload from a host processor subsystem in purpose built appliances and servers, such as Open vSwitch (OVS).

This figure shows an example of a T4240 built as a PCI Express form-factor supporting virtualization through SR-IOV with quad 10 G physical networking interfaces.



wuncore processing options

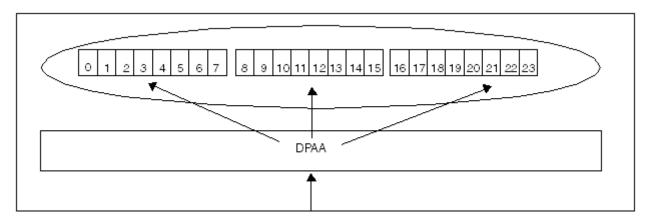


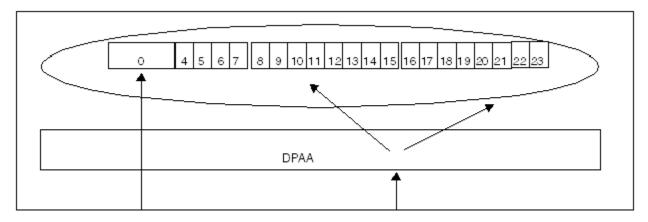
Figure 5. 24 vCPU AMP or SMP with affinity

# 4.2 Symmetric multiprocessing

Figure 5 also presents 24 vCPU SMP, where it is typical for data processing to involve some level of task affinity.

# 4.3 Mixed symmetric and asymmetric multiprocessing

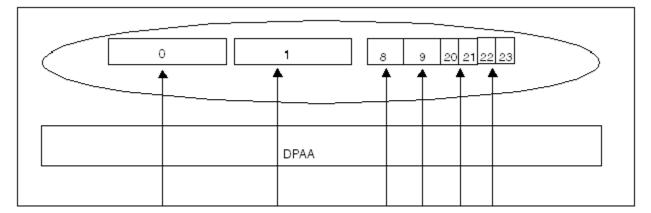
This figure shows one possibility for a mixed SMP and AMP processing. Two physical CPUs (vCPUs 0-3) are combined in an SMP cluster for control processing, with the Datapath using exact match classification to send only control packets to the SMP cluster. The remaining virtual cores could run 20 instances of datapath software.



### Figure 6. Mixed SMP and AMP option 1

This figure shows another possibility for mixed SMP and AMP processing. Two of the physical cores are run in single threaded mode; the remaining physical cores operate as four virtual CPUs. The Datapath directs traffic to specific software partitions based on physical Ethernet port, classification, or some combination.





#### Figure 7. Mixed SMP and AMP option 2

# 5 Chip features

This section describes the key features and functionalities of the T4240 chip. See the T4160 and T4080 appendices for those device's specific block diagrams.

# 5.1 Block diagram

This figure shows the major functional units within the chip.





### 5.7.1.1 DDR bandwidth optimizations

Multicore SoCs are able to increase CPU and network interface bandwidths faster than commodity DRAM technologies are improving. As a result, it becomes increasingly important to maximize utilization of main memory interfaces to avoid a memory bottleneck. The T4 family's DDR controllers are Freescale-developed IP, optimized for the QorIQ SoC architecture, with the goal of improving DDR bandwidth utilization by fifty percent when compared to first generation QorIQ SoCs.

Most of the WRITE bandwidth improvement and approximately half of the READ bandwidth improvement is met through target queue enhancements; in specific, changes to the scheduling algorithm, improvements in the bank hashing scheme, support for more transaction re-ordering, and additional proprietary techniques.

The remainder of the READ bandwidth improvement is due to the addition of an intelligent data prefetcher in the memory subsystem.

### 5.7.1.2 Prefetch Manager (PMan)

#### NOTE

All transactions to DDR pass through the CPC; this means the CPC can miss (and trigger prefetching) even on data that is not intended for allocation into the CPC.

The PMAN monitors CPC misses for opportunities to prefetch, using a "confidence"-based algorithm to determine its degree of aggressiveness. It can be configured to monitor multiple memory regions (each of different size) for prefetch opportunities. Multiple CPC misses on accesses to a tracked region for consecutive cache blocks increases confidence to start prefetching, and a CPC miss of a tracked region with same stride will instantly cause prefetching.

The PMan uses feedback to increase or decrease its aggressiveness. When the data it prefetches is being used, it prefetches further ahead. If the request stride length changes or previously prefetched data isn't consumed, prefetching slows or stops (at least for that region/requesting device/transaction type).

### 5.7.2 PreBoot Loader and nonvolatile memory interfaces

The PreBoot Loader (PBL) operates similarly to an I<sup>2</sup>C boot sequencer but on behalf of a large number of interfaces.

It supports IFC, I<sup>2</sup>C, eSPI, eSDHC.

The PBL's functions include the following:

- · Simplifies boot operations, replacing pin strapping resistors with configuration data loaded from nonvolatile memory
- Uses the configuration data to initialize other system logic and to copy data from low speed memory interfaces (I<sup>2</sup>C, IFC, eSPI, and SD/MMC) into fully initialized DDR or the 2 MB front-side cache

### 5.7.2.1 Integrated Flash Controller

The SoC incorporates an Integrated Flash Controller similar to the one used in some previous generation QorIQ SoCs. The IFC supports both NAND and NOR flash, as well as a general purpose memory mapped interface for connecting low speed ASICs and FPGAs.

#### 5.7.2.1.1 NAND Flash features

- x8/x16 NAND Flash interface
- Optional ECC generation/checking
- Flexible timing control to allow interfacing with proprietary NAND devices
- SLC and MLC Flash devices support with configurable page sizes of up to 4 KB
- · Support advance NAND commands like cache, copy-back, and multiplane programming



#### unp features

- Boot chip-select (CS0) available after system reset, with boot block size of 8 KB, for execute-in-place boot loading from NAND Flash
- Up to terabyte Flash devices supported

#### 5.7.2.1.2 NOR Flash features

- Data bus width of 8/16/32
- Compatible with asynchronous NOR Flash
- Directly memory mapped
- Supports address data multiplexed (ADM) NOR device
- · Flexible timing control allows interfacing with proprietary NOR devices
- Boot chip-select (CS0) available at system reset

### 5.7.2.1.3 General-purpose chip-select machine (GPCM)

The IFC's GPCM supports the following features:

- Normal GPCM
  - Support for x8/16/32-bit device
  - · Compatible with general purpose addressable device, for example, SRAM and ROM
  - External clock is supported with programmable division ratio (2, 3, 4, and so on, up to 16)
- Generic ASIC Interface
  - Support for x8/16/32-bit device
  - Address and Data are shared on I/O bus
  - Following address and data sequences are supported on I/O bus:
    - 32-bit I/O: AD
    - 16-bit I/O: AADD
    - 8-bit I/O: AAAADDDD

### 5.7.2.2 Serial memory controllers

In addition to the parallel NAND and NOR flash supported by the IFC, the SoC supports serial flash using eSPI, I<sup>2</sup>C and SD/MMC/eMMC card and device interfaces. The SD/MMC/eMMC controller includes a DMA engine, allowing it to move data from serial flash to external or internal memory following straightforward initiation by software.

Detailed features of the eSDHC include the following:

- Conforms to the SD Host Controller Standard Specification version 2.0, including Test event register support
- Compatible with the MMC System Specification version 4.2
- Compatible with the SD Memory Card Specification version 2.0, and supports the high capacity SD memory card
- Designed to work with SD memory, SD combo, MMC, and their variants like mini and micro.
- Card bus clock frequency up to 52 MHz
- Supports 1-/4-bit SD, 1-/4-/8-bit MMC modes
- · Supports single-block and multi-block read, and write data transfer
- Supports block sizes of 1-2048 bytes
- Supports the mechanical write protect detection. In the case where write protect is enabled, the host will not initiate any write data command to the card
- · Supports both synchronous and asynchronous abort
- Supports pause during the data transfer at block gap
- Supports Auto CMD12 for multi-block transfer
- · Host can initiate command that do not use data lines, while data transfer is in progress
- Embodies a configurable 128x32-bit FIFO for read/write data
- Supports SDMA, ADMA1, and ADMA2 capabilities



- Supports external SD bus voltage selection by register configuration
- Host will send 80 idle SD clock cycles to card, which are needed during card power-up, if bit INITA in the system control register (SYSCTL) is set

# 5.8 Universal serial bus (USB) 2.0

The two USB 2.0 controllers with integrated PHY provide point-to-point connectivity that complies with the USB specification, Rev. 2.0. Each of the USB controllers with integrated PHY can be configured to operate as a stand-alone host, and one of the controllers (USB #2) can be configured as a stand-alone device, or with both host and device functions operating simultaneously.

# 5.9 High-speed peripheral interface complex (HSSI)

This chip offers a variety of high-speed serial interfaces, sharing a set of 16 SerDes lanes. Each interface is backed by a high speed serial interface controller. This chip has the following types and quantities of controllers:

- Four 2.0 PCI Express controllers, two supporting 3.0
- Two Serial RapidIO 2.0
- Two SATA 2.0
- One Interlaken look-aside
- Aurora
- · Up to sixteen Ethernet controllers with various protocols

# 5.9.1 PCI Express

Each of the chip's PCI Express controllers is compliant with the PCI Express Base Specification Revision 2.0. Two are additionally compliant with Revision 3.0 (8 GHz). Key features of each PCI Express controller include the following:

- Power-on reset configuration options allow root complex or endpoint functionality.
- The physical layer operates at 2.5, 5, or 8 Gbaud data rate per lane.
- x4, x2, and x1 link widths supported on all controllers
- Two controllers can support x8 link width
- Both 32- and 64-bit addressing
- 256-byte maximum payload size
- Full 64-bit decode with 40-bit wide windows
- Inbound INTx transactions
- Message signaled interrupt (MSI) transactions
- · One PCI Express controller supports end-point SR-IOV
  - Two physical functions, each with 64 virtual functions
  - Eight MSI-X per virtual function



# 5.10.1 Packet distribution and queue/congestion management

This table lists some packet distribution and queue/congestion management offload functions.

#### Table 3. Offload functions

Function type	Definition	
Data buffer management	Supports allocation and deallocation of buffers belonging to pools originally created by software with configurable depletion thresholds. Implemented in a module called the Buffer Manager (BMan).	
Queue management	Supports queuing and quality-of-service scheduling of frames to CPUs, network interfaces and DPAA logic blocks, maintains packet ordering within flows. Implemented in a module called the Queue Manager (QMan). The QMan, besides providing flow-level queuing, is also responsible for congestion management functions such as RED/WRED, congestion notifications and tail discards.	
Packet distribution	Supports in-line packet parsing and general classification to enable policing and QoS-based packet distribution to the CPUs for further processing of the packets. This function is implemented in the block called the Frame Manager (FMan).	
Policing	Supports in-line rate-limiting by means of two-rate, three-color marking (RFC 2698). Up to 256 policing profiles are supported. This function is also implemented in the FMan.	
Egress Scheduling	Supports hierarchical scheduling and shaping, with committed and excess rates. This function is supported in the QMan, although the FMan performs the actual transmissions.	

# 5.10.2 Accelerating content processing

Properly implemented acceleration logic can provide significant performance advantages over most optimized software with acceleration factors on the order of 10-100x. Accelerators in this category typically touch most of the bytes of a packet (not just headers). To avoid consuming CPU cycles in order to move data to the accelerators, these engines include well-pipelined DMAs. This table lists some specific content-processing accelerators on the chip.

Table 4.	<b>Content-processing accelerators</b>
----------	--

Interface	Definition	
SEC	Crypto-acceleration for protocols such as IPsec, SSL, and 3GPP RLC	
PME	Regex style pattern matching for unanchored searches, including cross-packet stateful patterns	
DCE	Compression/Decompression acceleration for ZLib and deflate	

# 5.10.3 Enhancements of T4240 compared to first generation DPAA

A short summary of T4240 enhancements over the first generation DPAA (as implemented in the P4080) is provided below:

- Frame Manager
  - 2x performance increase (up to 25 Gbps per FMan)
  - Storage profiles.
  - HiGig (3.125 GHz) and HiGig2 (3.125 GHz and 3.75 GHz)
  - Energy Efficient Ethernet
- SEC 5.0
  - 2x performance increase for symmetric encryption and protocol processing

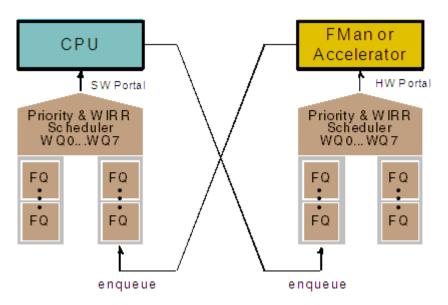


- Up to 20 Gbps for IPsec @ Imix
- 10x performance increase for public key algorithms
- Support for 3GPP Confidentiality and Integrity Algorithms 128-EEA3 & 128-EIA3 (ZUC)
- DCE 1.0, new accelerator for compression/decompression
- RMan (Serial RapidIO Manager)
- DPAA overall capabilities
  - Data Center Bridging
  - Egress Traffic Shaping

# 5.10.4 DPAA terms and definitions

The QorIQ Platform's Data Path Acceleration Architecture (henceforth DPAA) assumes the existence of network flows, where a flow is defined as a series of network datagrams, which have the same processing and ordering requirements. The DPAA prescribes data structures to be initialized for each flow. These data structures define how the datagrams associated with that flow move through the DPAA. Software is provided a consistent interface (the software portal) for interacting with hardware accelerators and network interfaces.

All DPAA entities produce data onto frame queues (a process called enqueuing) and consume data from frame queues (dequeuing). Software enqueues and dequeues through a software portal (each vCPU has two software portals), and the FMan, RMan, and DPAA accelerators enqueue/dequeue through hardware portals. This figure illustrates this key DPAA concept.





This table lists common DPAA terms and their definitions.

#### Table 5. DPAA terms and definitions

Term	Definition	Graphic representation
Buffer	Region of contiguous memory, allocated by software, managed by the DPAA BMan	в

Table continues on the next page ...



ump features

Term	Definition	Graphic representation
Buffer pool	Set of buffers with common characteristics (mainly size, alignment, access control)	ВВВ
Frame	Single buffer or list of buffers that hold data, for example, packet payload, header, and other control information	
Frame queue (FQ)	FIFO of frames	FQ = F F
Work queue (WQ)	FIFO of FQs	WQ = FQ FQ
Channel	Set of eight WQs with hardware provided prioritized access	$Chan = \frac{0  FQ  FQ}{7  FQ  FQ}  Priority$
Dedicated channel	Channel statically assigned to a particular end point, from which that end point can dequeue frames. End point may be a CPU, FMan, PME,DCE,RMan or SEC.	-
Pool channel	A channel statically assigned to a group of end points, from which any of the end points may dequeue frames.	

#### Table 5. DPAA terms and definitions (continued)

### 5.10.5 Major DPAA components

The SoC's Datapath Acceleration Architecture, shown in the figure below, includes the following major components:

- Frame Manager (FMan)
- Queue Manager (QMan)
- Buffer Manager (BMan)
- RapidIO Message Manager (RMan 1.0)
- Security Engine (SEC 5.0)
- Pattern Matching Engine (PME 2.1)
- Decompression and Compression Engine (DCE 1.0)

The QMan and BMan are infrastructure components, which are used by both software and hardware for queuing and memory allocation/deallocation. The Frame Managers and RMan are interfaces between the external world and the DPAA. These components receive datagrams via Ethernet or Serial RapidIO and queue them to other DPAA entities, as well as dequeue datagrams from other DPAA entities for transmission. The SEC, PME, and DCE are content accelerators that dequeue processing requests (typically from software) and enqueue results to the configured next consumer. Each component is described in more detail in the following sections.



This figure is a logical view of the DPAA.

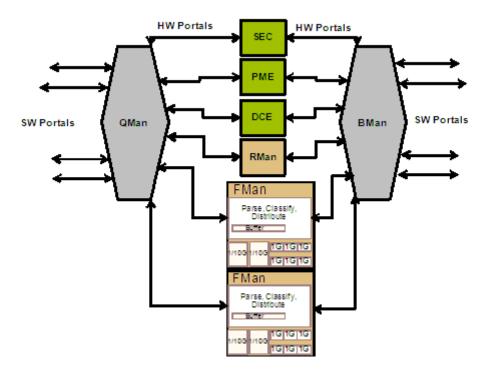


Figure 10. Logical representation of DPAA

### 5.10.5.1 Frame Manager and network interfaces

The chip incorporates two enhanced Frame Managers. The Frame Manager improves on the bandwidth and functionality offered in the P4080.

Each Frame Manager, or FMan, combines Ethernet MACs with packet parsing and classification logic to provide intelligent distribution and queuing decisions for incoming traffic. Each FMan supports PCD at 37.2 Mpps, supporting line rate 2x10G + 2x2.5G at minimum frame size.

These Ethernet combinations are supported:

- 10 Gbps Ethernet MACs are supported with XAUI (four lanes at 3.125 GHz) or XFI (one lane at 10.3125 GHz SerDes).
- 1 Gbps Ethernet MACs are supported with SGMII (one lane at 1.25 GHz with 3.125 GHz option for 2.5 Gbps Ethernet).
  - SGMIIs can be run at 3.125 GHz so long as the total Ethernet bandwidth does not exceed 25 Gbps on the associated FMan.
  - If not already assigned to SGMII, two MACs can be used with RGMII.
- Four x1Gbps Ethernet MACs can be supported using a single lane at 5 GHz (QSGMII).
- HiGig is supported using four lanes at 3.125 GHz or 3.75 GHz (HiGig2).

The Frame Manager's Ethernet functionality also supports the following:

- 1588v2 hardware timestamping mechanism in conjunction with IEEE Std. 802.3bf (Ethernet support for time synchronization protocol)
- Energy Efficient Ethernet (IEEE Std. 802.3az)
- IEEE Std. 802.3bd (MAC control frame support for priority based flow control)
- IEEE Std. 802.1Qbb (Priority-based flow control) for up to eight queues/priorities
- IEEE Std. 802.1Qaz (Enhanced transmission selection) for three or more traffic classes



Table 6.	Parser header types (continued)	

Header type	Definition	
	For example, a frame that always contains a proprietary header before the Ethernet header would be non-self-describing. Both self-describing and non-self-describing headers are supported by means of parsing rules in the FMan.	
Proprietary	Can be defined as being self-describing or non-self-describing	

The underlying notion is that different frames may require different treatment, and only through detailed parsing of the frame can proper treatment be determined.

Parse results can (optionally) be passed to software.

### 5.10.5.1.2 FMan distribution and policing

After parsing is complete, there are two options for treatment, as shown in this table.

Treatment	Function	Benefits
Hash		Useful when spreading traffic while obeying QoS constraints is required
Classification look-up	<ul> <li>Looks up certain fields in the frame to determine subsequent action to take, including policing.</li> <li>The FMan contains internal memory that holds small tables for this purpose.</li> <li>The user configures the sets of lookups to perform, and the parse results dictate which one of those sets to use.</li> <li>Lookups can be chained together such that a successful look-up can provide key information for a subsequent look-up. After all the look-ups are complete, the final classification result provides either a hash key to use for spreading, or a FQ ID directly.</li> </ul>	<ul> <li>Useful when hash distribution is insufficient and a more detailed examination of the frame is required</li> <li>Can determine whether policing is required and the policing context to use</li> </ul>

#### Table 7. Post-parsing treatment options

Key benefits of the FMan policing function are as follows:

- Because the FMan has up to 256 policing profiles, any frame queue or group of frame queues can be policed to either drop or mark packets if the flow exceeds a preconfigured rate.
- Policing and classification can be used in conjunction to mitigate Distributed Denial of Service Attack (DDOS).
- The policing is based on the two-rate-three-color marking algorithm (RFC2698). The sustained and peak rates, as well as the burst sizes, are user-configurable. Therefore, the policing function can rate-limit traffic to conform to the rate that the flow is mapped to at flow set-up time. By prioritizing and policing traffic prior to software processing, CPU cycles can focus on important and urgent traffic ahead of other traffic.

Each FMan also supports PCD on traffic arriving from within the chip. This is referred to as off-line parsing, and it is useful for reclassification following decapsulation of encrypted or compressed packets.

FMan PCD supports virtualization and strong partitioning by delaying buffer pool selection until after classification. In addition to determining the FQ ID for the classified packet, the FMan also determines the 'storage profile.' Configuration of storage profiles (up to 32 per physical port) allows the FMan to store received packets using buffer pools owned by a single software partition, and enqueue the associated Frame Descriptor to a frame queue serviced by only that software partition.



The SEC 5.0 can perform full protocol processing for the following security protocols:

- IPsec
- SSL/TLS
- 3GPP RLC encryption/decryption
- LTE PDCP
- SRTP
- IEEE 802.1AE MACSec
- IEEE 802.16e WiMax MAC layer

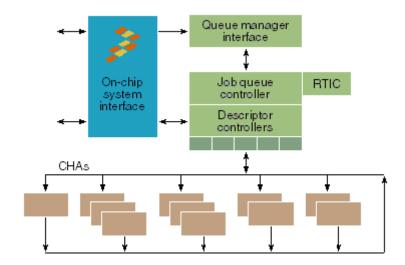
The SEC 5.0 supports the following algorithms, modes, and key lengths as raw modes, or in combination with the security protocol processing described above.

- Public Key Hardware Accelerators (PKHA)
  - RSA and Diffie-Hellman (to 4096b)
  - Elliptic curve cryptography (1023b)
- Data Encryption Standard Accelerators (DESA)
  - DES, 3DES (2-key, 3-key)
  - ECB, CBC, OFB, and CFB modes
- Advanced Encryption Standard Accelerators (AESA)
  - Key lengths of 128-bit, 192-bit, and 256-bit
    - ECB, CBC, CTR, CCM, GCM, CMAC, OFB, CFB, xcbc-mac, and XTS
- ARC Four Hardware Accelerators (AFHA)
  - Compatible with RC4 algorithm
- Message Digest Hardware Accelerators (MDHA)
  - SHA-1, SHA-256, 384, 512-bit digests
  - MD5 128-bit digest
  - HMAC with all algorithms
- Kasumi/F8 Hardware Accelerators (KFHA)
  - F8, F9 as required for 3GPP
  - A5/3 for GSM and EDGE, GEA-3 for GPRS
- Snow 3G Hardware Accelerators (SNOWf8 and SNOWf9)
  - Implements Snow 3.0, F8 and F9 modes
- ZUC Hardware Accelerators (ZUCE and ZUCA)
  - Implements 128-EEA3 & 128-EIA3
- CRC Unit
  - Standard and user-defined polynomials
- Random Number Generator
  - Incorporates TRNG entropy generator for seeding and deterministic engine (SHA-256)
  - Supports random IV generation

The SEC 5.0 is designed to support bulk encryption at up to 40 Gbps, large packet/record IPsec/SSL at up to 30 Gbps, and 20 Gbps for IPsec ESP at Imix packet sizes. 3G and LTE algorithms are supported at 10 Gbps or more.

The SEC dequeues data from its QMan hardware portal and, based on FQ configuration, also dequeues associated instructions and operands in the Shared Descriptor. The SEC processes the data then enqueues it to the configured output FQ. The SEC uses the Status/CMD word in the output Frame Descriptor to inform the next consumer of any errors encountered during processing (for example, received packet outside the anti-replay window.)





#### Figure 12. SEC 5.0 block diagram

The SEC 5.0 is also part of the QorIQ Platform's Trust Architecture, which gives the SoC the ability to perform secure boot, runtime code integrity protection, and session key protection. The Trust Architecture is described in Resource partitioning and QorIQ Trust Architecture.

# 5.10.5.5 Pattern Matching Engine (PME 2.1)

The PME 2.1 is Freescale's second generation of extended NFA style pattern matching engine. Unchanged from the first generation QorIQ products, it supports ~10 Gbps data scanning.

Key benefits of a NFA pattern matching engine:

- No pattern "explosion" to support "wildcarding" or case-insensitivity
  - Comparative compilations have shown 300,000 DFA pattern equivalents can be achieved with ~8000 extended NFA patterns
- Pattern density much higher than DFA engines.
  - Patterns can be stored in on-chip tables and main DDR memory
  - Most work performed solely with on-chip tables (external memory access required only to confirm a match)
  - No need for specialty memories; for example, QDR SRAM, RLDRAM, and so on.
- Fast compilation of pattern database, with fast incremental additions
  - Pattern database can be updated without halting processing
  - · Only affected pattern records are downloaded
  - DFA style engines can require minutes to hours to recompile and compress database

Freescale's basic NFA capabilities for byte pattern scanning are as follows:

- The PME's regex compiler accepts search patterns using syntax similar to that in software-based regex engines, such as Perl-Compatible Regular Expression (PCRE).
  - Supports Perl meta-characters including wildcards, repeats, ranges, anchors, and so on.
  - Byte patterns are simple matches, such as gabcd123h, existing in both the data being scanned and in the pattern specification database.
- Up to 32 KB patterns of length 1-128 bytes

Freescale's extensions to NFA style pattern matching are principally related to event pattern scanning. Event patterns are sequences of byte patterns linked by 'stateful rules.' Freescale uses event pattern scanning and stateful rule processing synonymously. Stateful rules are hardware instructions by which users define reactions to pattern match events, such as state changes, assignments, bitwise operations, addition, subtraction, and comparisons.

Some key characteristics and benefits of the Stateful Rule extensions include:



- Jup features
  - · All standard modes of decompression
  - No compression
  - Static Huffman codes
  - Dynamic Huffman codes
  - Provides option to return original compressed Frame along with the uncompressed Frame or release the buffers to BMan
  - Does not support use of ZLIB preset dictionaries (FDICT flag = 1 is treated as an error).
  - Base 64 decoding (RFC4648) prior to decompression

The DCE 1.0 is designed to support up to 8.8 Gbps for either compression or decompression, or 17.5 Gbps aggregate at ~4 KB data sizes.

## 5.10.6 DPAA capabilities

Some DPAA features and capabilities have been described in the sections covering individual DPAA components. This section describes some capabilities enabled by DPAA components working together.

### 5.10.6.1 Ingress policing and congestion management

In addition to selecting FQ ID and storage profile, classification can determine whether policing is required for a received packet, along with the specific policing context to be used.

FMan policing capabilities include the following:

- RFC2698: two-rate, three-color marking algorithm
- RFC4115: Differentiated service two-rate, three-color marker with efficient handling of in-profile traffic
- Up to 256 internal profiles

The sustained and peak rates, and burst size for each policing profile are user-configurable.

### 5.10.6.2 Customer-edge egress-traffic management (CEETM)

Customer-edge egress-traffic management (CEETM) is a DPAA enhancement first appearing in the T4240. T4240 continues to support the work queue and frame queue scheduling functionality available in the P4080 and other first generation QorIQ chips, but introduces alternative functionary, CEETM, that can be mode selected on a network interface basis to support the shaping and scheduling requirements of carrier Ethernet connected systems.

### 5.10.6.2.1 CEETM features

Each instance of CEETM (one per FMan) provides the following features:

- Supports hierarchical multi-level scheduling and shaping, which:
  - is performed in an atomic manner; all context at all levels is examined and updated synchronously.
  - employs no intermediate buffering between class queues and the direct connect portal to the FMan.
- Supports dual-rate shaping (paired committed rate (CR) shaper and excess rate (ER) shaper) at all shaping points.
  - Shapers are token bucket based with configurable rate and burst limit.
  - Paired CR/ER shapers may be configured as independent or coupled on a per pair basis; coupled means that credits to the CR shaper in excess of its token bucket limit is credited to the ER bucket
- Supports eight logical network interfaces (LNI)
  - Each LNI:
    - aggregates frames from one or more channels.
    - priority schedules unshaped frames (aggregated from unshaped channels), CR frames, and ER frames (aggregated from shaped channels)



# 5.12 Advanced power management

Power dissipation is always a major design consideration in embedded applications; system designers need to balance the desire for maximum compute and IO density against single-chip and board-level thermal limits.

Advances in chip and board level cooling have allowed many OEMs to exceed the traditional 30 W limit for a single chip, and Freescale's flagship T4240 multicore chip, has consequently retargeted its maximum power dissipation. A top-speed bin T4240 dissipates approximately 2x the power dissipation of the P4080; however, the T4240 increases computing performance by ~4x, yielding a 2x improvement in DMIPs per watt.

Junction temperature is a critical factor in comparing embedded processor specifications. Freescale specs max power at 105C junction, standard for commercial, embedded operating conditions. Not all multicore chips adhere to a 105C junction for specifying worst case power. In the interest of normalizing power comparisons, the chip's typical and worst case power (all CPUs at 1.8 GHz) are shown at alternate junction temperatures.

To achieve the previously-stated 2x increase in performance per watt, the chip implements a number of software transparent and performance transparent power management features. Non-transparent power management features are also available, allowing for significant reductions in power consumption when the chip is under lighter loads; however, non-transparent power savings are not assumed in chip power specifications.

# 5.12.1 Transparent power management

This chip's commitment to low power begins with the decision to fabricate the chip in 28 nm bulk CMOS. This process technology offers low leakage, reducing both static and dynamic power. While 28 nm offers inherent power savings, transistor leakage varies from lot to lot and device to device. Leakier parts are capable of faster transistor switching, but they also consume more power. By running devices from the leakier end of the process spectrum at less than nominal voltage and devices from the slower end of the process spectrum at higher nominal voltage, T4240-based systems can achieve the required operating frequency within the specified max power. During manufacturing, Freescale will determine the voltage required to achieve the target frequency bin and program this Voltage ID into each device, so that initialization software can program the system's voltage regulator to the appropriate value.

Dynamic power is further reduced through fine-grained clock control. Many components and subcomponents in the chip automatically sleep (turn off their clocks) when they are not actively processing data. Such blocks can return to full operating frequency on the clock cycle after work is dispatched to them. A portion of these dynamic power savings are built into the chip max power specification on the basis of impossibility of all processing elements and interfaces in the chip switching concurrently. The percent switching factors are considered quite conservative, and measured typical power consumption on QorIQ chips is well below the maximum in the data sheet.

As noted in Frame Manager and network interfaces, the chip supports Energy-Efficient Ethernet. During periods of extended inactivity on the transmit side, the chip transparently sends a low power idle (LPI) signal to the external PHY, effectively telling it to sleep.

Additional power savings can be achieved by users statically disabling unused components. Developers can turn off the clocks to individual logic blocks (including CPUs) within the chip that the system is not using. Based on a finite number of SerDes, it is expected that any given application will have some inactive Ethernet MACs, PCI Express, or serial RapidIO controllers. Re-enabling clocks to a logic block generally requires an chip reset, which makes this type of power management infrequent (effectively static) and transparent to runtime software.



Conclusion

# 5.13 Debug support

The reduced number of external buses enabled by the move to multicore chips greatly simplifies board level lay-out and eliminates many concerns over signal integrity. Even though the board designer may embrace multicore CPUs, software engineers have real concerns over the potential to lose debug visibility. Despite the problems external buses can cause for the hardware engineer, they provide software developers with the ultimate confirmation that the proper instructions and data are passing between processing elements.

Processing on a multicore chip with shared caches and peripherals also leads to greater concurrency and an increased potential for unintended interactions between device components. To ensure that software developers have the same or better visibility into the device as they would with multiple discrete communications processors, Freescale developed an Advanced Multicore Debug Architecture.

The debugging and performance monitoring capability enabled by the device hardware coexists within a debug ecosystem that offers a rich variety of tools at different levels of the hardware/software stack. Software development and debug tools from Freescale (CodeWarrior), as well as third-party vendors, provide a rich set of options for configuring, controlling, and analyzing debug and performance related events.

# 6 Conclusion

Featuring 24 virtual cores, and based on the dual-threaded e6500 Power Architecture core, the T4240 processor, along with its 16 (T4160) and 8 (T4080) virtual-core variants, offers frequencies up to 1.8 GHz, large caches, hardware acceleration, and advanced system peripherals. All three devices target applications that benefit from consolidation of control and data plane processing in a single chip. In addition, each e6500 core implements the Freescale AltiVec technology SIMD engine, dramatically boosting the performance of math-intensive algorithms without using additional DSP components on the board. A wide variety of applications can benefit from the processing, I/O integration, and power management offered for the T4 series processors. Similar to other QorIQ devices, the T4 family processors' high level of integration offers significant space, weight, and power benefits compared to multiple discrete devices. Freescale also offers fully featured development support, which includes the QorIQ T4240 QDS Development System, QorIQ T4240 Reference Design Board, Linux SDK for QorIQ Processors, as well as popular operating systems and development tools from a variety of vendors. See the Freescale website for the latest information on tools and SW availability.

For more information about the QorIQ T4 family, contact your Freescale sales representative.

# Appendix A T4160

# A.1 Introduction

The T4160 is a lower power version of the T4240. The T4160 combines eight dual threaded Power Architecture e6500 cores and two memory complexes (CoreNet platform cache and DDR3 memory controller) with the same high-performance datapath acceleration, networking, and peripheral bus interfaces.

This figure shows the major functional units within the chip.



#### Overview of differences between T4240 and T4160

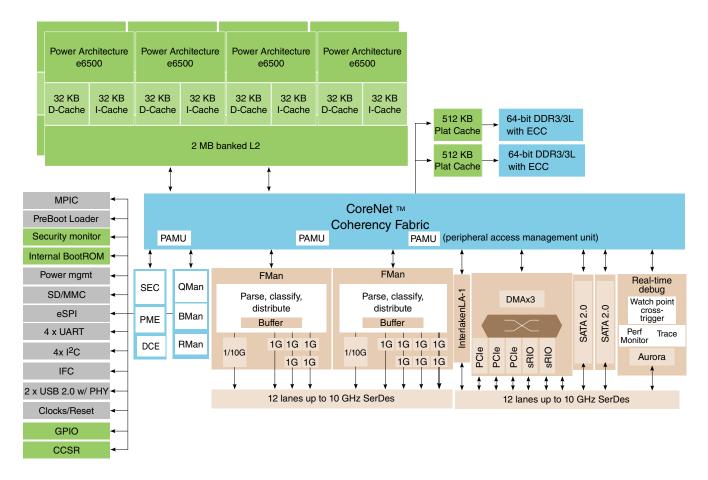


Figure A-1. T4160 block diagram

### A.2 Overview of differences between T4240 and T4160 Table A-1. Differences between T4240 and T4160

Feature	T4240	T4160
	Cores	-
Number of physical cores	12	8
Number of threads	24	16
Number of clusters	3	2
	Memory subsystem	
Total CPC memory	3 x 512 KB	2 x 512 KB
Number of DDR controllers	3	2
	Peripherals	
Number of Frame Managers	2	2
Total number of Anyspeed MACs	8 per Frame Manager	6 (FMan1) and 8 (FMan2)

Table continues on the next page...



Rev. number	Date	Substantive change(s)
1	10/2014	<ul> <li>Added support for T4080 throughout document.</li> <li>Updated Introduction.</li> <li>In Summary of benefits, updated the first sentence to include "SDN switches or controllers, network function virtualization" and added the following subsections: <ul> <li>e6500 CPU core</li> <li>Virtualization</li> <li>Data Path Acceleration Architecture (DPAA)</li> <li>System peripherals and networking</li> </ul> </li> <li>In Intelligent network adapter, added examples.</li> <li>Updated Block diagram.</li> <li>In Features summary, added T4160 and T4080 thread specifications, added 10GBase-KR to the Ethernet interfaces, updated the coherent read bandwidth, and removed the note.</li> <li>In Critical performance parameters, removed the typical power consumption table.</li> <li>In Core and CPU clusters, updated the 16 way, set associative sub-bullets and changed the double-precision, full device value from "42.2" to "up to 42.4".</li> <li>Updated HiGig 2 in Enhancements of T4240 compared to first generation DPAA.</li> <li>Updated bullet two in CoreNet fabric and address map and updated the last bullet in Highspeed peripheral interface complex (HSSI).</li> <li>Updated Non-transparent power management.</li> <li>Rewrote Conclusion to add more information and a list of Freescale resources.</li> <li>In the Appendix A T4160 Introduction, removed the T4240-specific information.</li> </ul>
0	06/2013	Initial public release.